Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.					This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.											
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Type http://www.ipc.org/IPC-175x Distribute				Form Type Distribute	*	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materia					als and Mfg Information				
Supplier	Information															
Company name* Company uni				que ID			Unique ID Authority					Response Date*				
onsemi													2025-05-11			
Contact N	ame	Title - Contact			1	Phone - Contact*					Email - Contact*					
Product-E	Env-Stewards		Product Envi	Product Enviro Compliance			NA				Product-Env-Stewards@onsemi.com					
Authorize	d Representative*	Title - Representative			1	Phone - Representative*				Email - Representative*						
Product-E	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com						
	Requester Item Number Mfr Item		Number Mfr Item Name				Effective Da			ring Site	We	ight*	UOM	Unit Type		
		NXH200 SG	XH200T120H3Q2F2 80kW Gen-II Q2PA			odule	2025-05-11			175	618.11	mg	Each			
Manufa	cturing Proccess Informat	tion														
	Terminal Plating / Grid Array Material T		Ferminal Base Alloy J-S		J-STD-020 MSL	_ Rating	Peak Pro	Process Body Temperature Ma		re Max Ti	me at Peak	ak Temperature N		r of Reflow Cyc	eles	
	Matte Tin (Sn) - annealed		CU Alloy NA		NA		0		С	30		seconds	3			
Comments																
or more i	information regarding material	composition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of						
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Case	10330.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		3615.5	mg
			Supplier	PBT	26062-94-2		6714.4995	mg
Case Lid	6690.0	mg	Supplier	Fiber Glass (SiO2)	65997-17-3		2341.5	mg
			Supplier	PBT	26062-94-2		4348.5	mg
DBC	17490.0	mg	Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		6996	mg
			Supplier	Copper (Cu)	7440-50-8		10494	mg
Die	219.105	mg	Supplier	Silicon Carbide	409-21-2		219.105	mg
			Supplier	Silicon (Si)	7440-21-3		0	mg
Glue	410.0	mg	Supplier	2,3-epoxypropyl-trimethoxysilan	2530-83-8		41	mg
			Supplier	Miscellaneous	Trade Secret		41	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		328	mg
Heat Sink	123450.0	mg	В	Nickel (Ni)	7440-02-0		1913.475	mg
			Supplier	Copper (Cu)	7440-50-8		121536.5234	mg
NTC	10.0	mg	Supplier	Silver (Ag)	7440-22-4		0.0979	mg
			Supplier	Tin (Sn)	7440-31-5		0.02	mg
			Supplier	Nickel Oxide (NiO)	1313-99-1		3.9169	mg
			Supplier	Palladium (Pd)	7440-05-3		0.0999	mg
			В	Nickel (Ni)	7440-02-0		0.01	mg
			Supplier	Cobalt Oxide (Co3O4)	1308-06-1		0.3997	mg
			Supplier	Manganese Tetraoxide (Mn3O4)	1317-35-7		5.4556	mg
Silicone Gel	8400.0	mg	Supplier	Silica, [(ethenyldimethylsilyl)oxy]- and [(trimethylsilyl)oxy]- modified	68988-89-6		2520	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		5880	mg
Solder Paste	5040.0	mg	Supplier	Silver (Ag)	7440-22-4		327.6	mg
			Supplier	Tin (Sn)	7440-31-5		4712.3999	mg
			Supplier	Copper (Cu)	7440-50-8		-151.2004	mg
Terminal	3540.0	mg	Supplier	Silicon (Si)	7440-21-3		9.558	mg
			В	Nickel (Ni)	7440-02-0		47.79	mg
			Supplier	Copper (Cu)	7440-50-8		3481.7671	mg
			Supplier	Phosphorus (P)	7723-14-0		0.885	mg
Wire Bond - Al	39.0	mg	Supplier	Aluminum (Al)	7429-90-5		39	mg